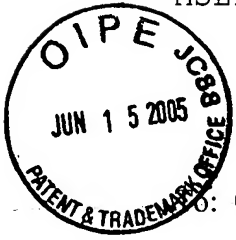


Jfw

June 13, 2005



To: Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Fr: Stephen B. Ackerman, Reg. No. 37,761
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject:

Serial No. 10/783,195 02/20/04

MOU-SHIUNG LIN

"TOP LAYERS OF METAL FOR HIGH
PERFORMANCE IC'S"

Grp. Art Unit: 2814 LE, THAO X

RESPONSE TO RESTRICTION REQUIREMENT AND PRELIMINARY AMENDMENT

Dear Sir:

In response to the Restriction Requirement mailed April 13, 2005, please amend the
above-identified application for patent as follows:

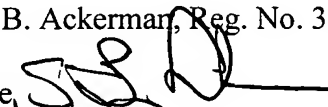
CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal
Service as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box
1450, Alexandria, VA 22313-1450, on June 13, 2005.

Stephen B. Ackerman, Reg. No. 37,761

Signature

Date


6/13/05

Amendments to the Specification begin on page 3 of this paper.

Amendments to the Claims are reflected in the listing of the Claims which begins on page 6 of this paper.

Amendments to the Drawings begin on page 13 of this paper and include an attached replacement sheet.

Remarks/Arguments begin on page 14 of this paper.

An Appendix including amended drawing figures is attached following page 14 of this paper.